

#### Application

- · Motor drive
- · Inverter, Converter
- · Photovoltaics, wind power generation.
- · Induction heating equipment.

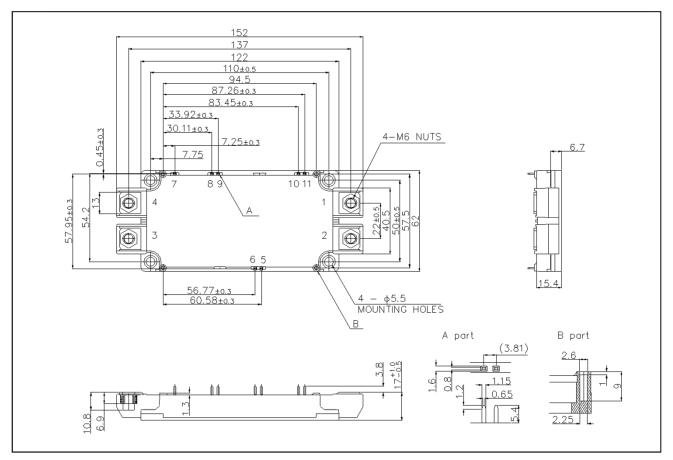
#### Features

- 1) Low surge, low switching loss.
- 2) High-speed switching possible.
- 3) Reduced temperature dependence.

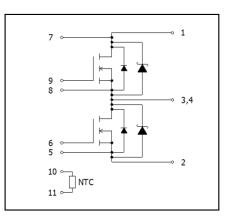
#### Construction

This product is a half bridge module consisting of SiC-DMOSFET and SiC-SBD from ROHM.

#### •Dimensions & Pin layout (Unit : mm)



#### Circuit diagram



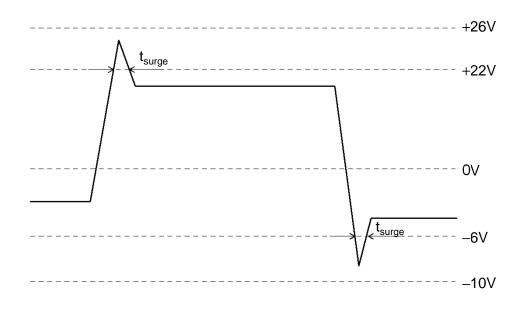
Parameter	Symbol	Conditions	Limit	Unit	
Drain-source voltage	V <sub>DSS</sub>	G-S short	1200		
Gate-source voltage(+)	V	D-S short	22	V	
Gate-source voltage(-)	V <sub>GSS</sub>	V <sub>GSS</sub> D-3 short	-6		
G - S Voltage (t <sub>surge</sub> <300nsec)	V <sub>GSS_surge</sub>	D-S short	-10 to 26		
	I <sub>D</sub>	DC (T <sub>c</sub> =60°C)	204		
Drain current * <sup>1</sup>	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 1ms * <sup>2</sup>	360		
	I <sub>DRM</sub>	Pulse (T <sub>c</sub> =60°C) 10us * <sup>2</sup>	540		
	ا <sub>S</sub>	DC (T <sub>c</sub> =60°C ) V <sub>GS</sub> =18V	204	A	
Source current *1	I <sub>SRM</sub>	I <sub>SRM</sub> Pulse (Tc=60°C) 1ms V <sub>GS</sub> =18V * <sup>2</sup>			
	I <sub>SRM</sub>	Pulse (Tc=60°C) 10us V <sub>GS</sub> =18V * <sup>2</sup>	540		
Total power disspation *3	Ptot	T <sub>c</sub> =25°C	1360	W	
Max Junction Temperature	T <sub>jmax</sub>		175		
Operating junction temperature			-40 to150	°C	
Storage temperature	T <sub>stg</sub>		-40 to125		
Isolation voltage	Visol	Terminals to baseplate, f=60Hz AC 1min.	2500	Vrms	
		Main Terminals : M6 screw	4.5		
Mounting torque	_	Mounting to heat shink : M5 screw	3.5	N ⋅ m	

#### ●Absolute maximum ratings (T<sub>i</sub> = 25°C)

(\*1) Case temperature  $(T_c)$  is defined on the surface of base plate just under the chips.

(\*2) Repetition rate should be kept within the range where temperature rise if die should not exceed  $T_{j max.}$  (\*3)  $T_j$  is less than 175°C

#### Example of acceptable $V_{\text{GS}}$ waveform



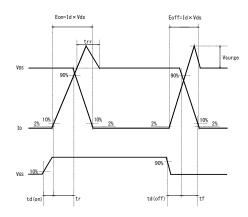
#### •Electrical characteristics (T<sub>i</sub>=25°C)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Ctatia drain aguras an atata			T <sub>j</sub> =25°C	-	2.2	3.2	V
Static drain-source on-state voltage	V <sub>DS(on)</sub>	I <sub>D</sub> 180A, V <sub>GS</sub> =18V	T <sub>j</sub> =125°C	-	3.1	-	
vonage			T <sub>j</sub> =150°C	-	3.5	5.0	
Drain cutoff current	I <sub>DSS</sub>	$V_{DS}$ =1200V, $V_{GS}$ =0V		-	-	3.2	mA
		V <sub>GS</sub> =0V, I <sub>S</sub> =180A	T <sub>j</sub> =25°C	-	1.6	2.2	
			T <sub>j</sub> =125°C		2	-	
Source-drain voltage	$V_{SD}$		T <sub>j</sub> =150°C	-	2.2	3.3	V
Source-drain voltage	▼ SD		T <sub>j</sub> =25°C	-	1.3	-	V
		V <sub>GS</sub> =18V, I <sub>S</sub> =180A	T <sub>j</sub> =125°C		1.5	-	
			T <sub>j</sub> =150°C	-	1.6	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =35.2mA		1.6	-	4	V
Gate-source leakage current	I <sub>GSS</sub>	$V_{GS}$ =22V, $V_{DS}$ =0V	-	-	0.5	μA	
		$V_{GS}$ = -6V, $V_{DS}$ =0V	-0.5	-	-		
	t <sub>d(on)</sub>	V <sub>GS(on)</sub> =18V, V <sub>GS(off)</sub> =0V		-	45	-	ns
	t <sub>r</sub>	V <sub>DS</sub> =600V	-	45	-		
Switching characteristics	t <sub>rr</sub>	I <sub>D</sub> =180A	I	45	-		
	t <sub>d(off)</sub>	$R_{G(on)}$ =1.0 $\Omega$ , $R_{G}$ =0.2 $\Omega$ inductive load		-	125	-	
	t <sub>f</sub>			-	45	-	
Input capacitance	Ciss	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, 200	-	18	-	nF	
Gate Registance	R <sub>Gint</sub>	Tj=25°C	-	1.2	-	Ω	
NTC Rated Resistance	R25			5.0		kΩ	
NTC B Value	B50/25				3370		К
Stray Inductance	Ls				13.0	-	nH
Creepage Distance		Terminal to heat sink			14.5	-	mm
	-	Terminal to terminal			15.0	-	mm
Clearance Distance	-	Terminal to heat sink			12.0	-	mm
		Terminal to terminal		9.0	-	mm	
Junction-to-case thermal	R <sub>th</sub> (j-c)	DMOS (1/2 module) * <sup>4</sup>		-	-	0.11	°C/W
resistance	ν <sub>th</sub> (j-υ)	SBD (1/2 module) * <sup>4</sup>	-	-	0.14		
Case-to-heat sink Thermal resistance	R <sub>th</sub> (c-f)	Case to heat sink, per Thermal grease applie	-	0.035	-		

(\*4) Measurement of Tc is to be done at the point just under the chip.

- (\*5) Typical value is measured by using thermally conductive grease of  $\lambda$ =0.9W/(m · K).
- (\*6) If the Product is used beyond absolute maximum ratings defined in the Specifications, as its internal structure may be dameged, please replace such Product with a new one.

#### <Wavelength for Switching Test>





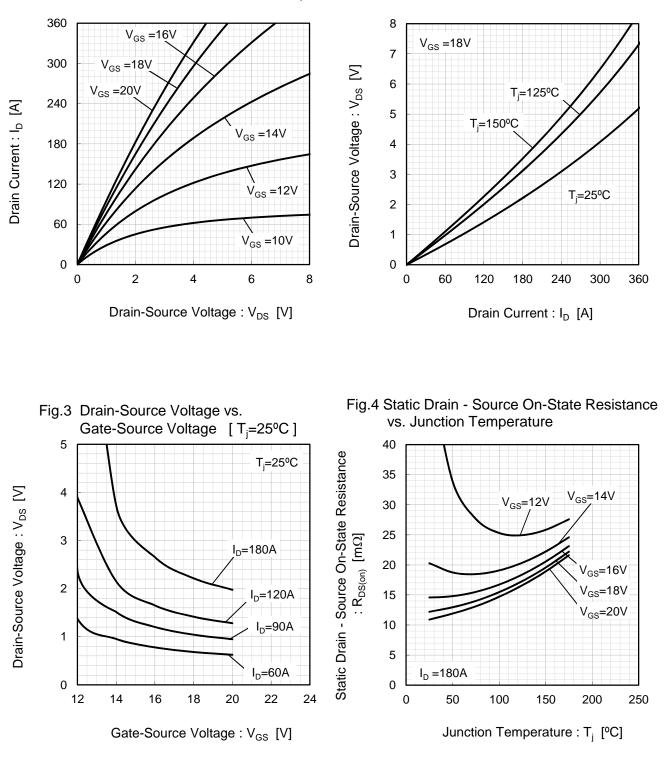
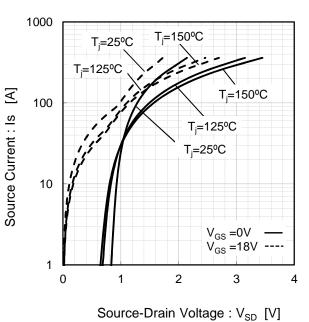
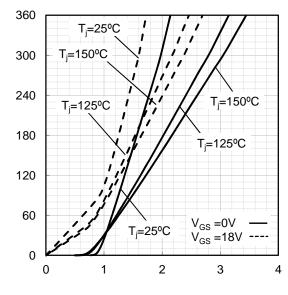


Fig.1 Typical Output Characteristics [T<sub>i</sub>=25°C] Fig.2 Drain-Source Voltage vs. Drain Current



#### Fig.5 Forward characteristic of Diode

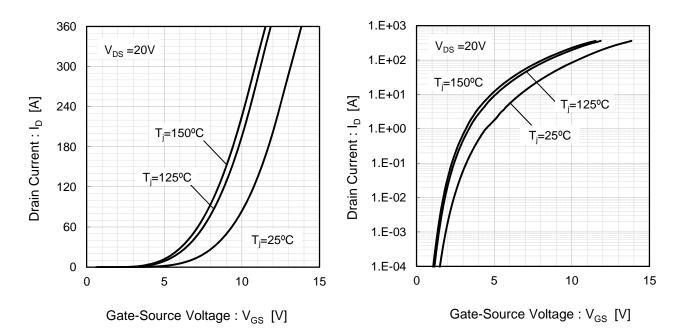
Fig.6 Forward characteristic of Diode



Source-Drain Voltage :  $V_{SD}$  [V]

#### Fig.7 Drain Current vs. Gate-Source Voltage

#### Fig.8 Drain Current vs. Gate-Source Voltage



Source Current : Is [A]

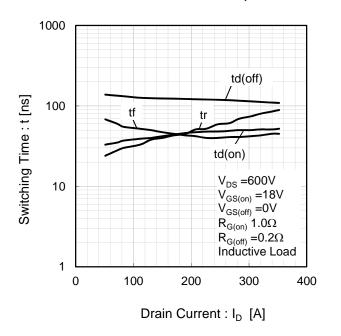
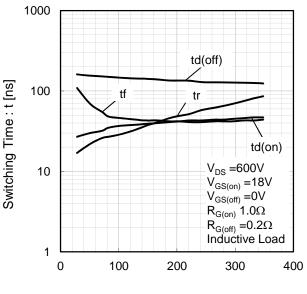


Fig.9 Switching Characteristics [T<sub>i</sub>=25°C]

Fig.10 Switching Characteristics [T<sub>i</sub>=125°C]



Drain Current :  $I_D$  [A]

### Fig.11 Switching Characteristics [ $T_j$ =150°C]

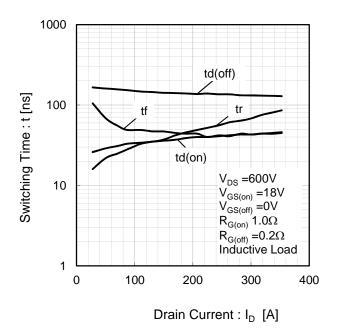
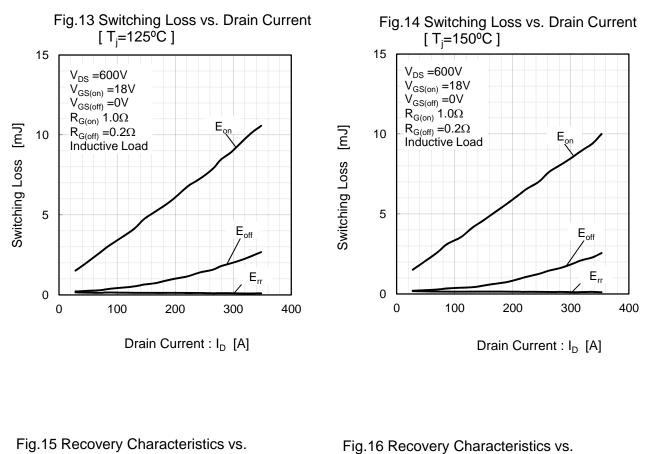
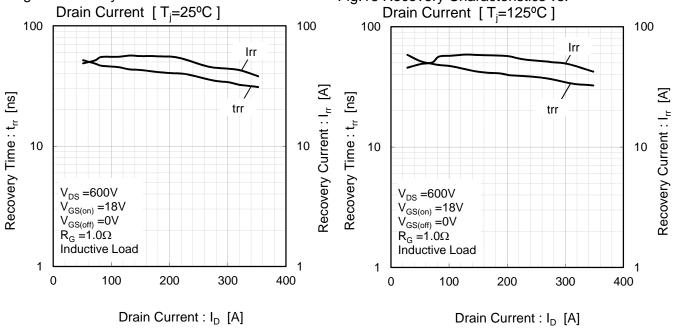


Fig.12 Switching Loss vs. Drain Current [T<sub>i</sub>=25°C] 20 V<sub>DS</sub> =600V  $V_{GS(on)} = 18V$  $V_{GS(off)} = 0V$  $R_{G(on)}$  1.0 $\Omega$ 15  $R_{G(off)} = 0.2\Omega$ Inductive Load [m] Eon Switching Loss 10 5 E Err 0 0 100 200 300 400 Drain Current : I<sub>D</sub> [A]





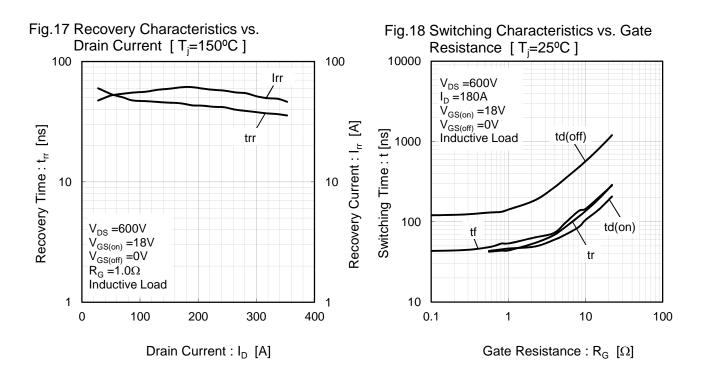
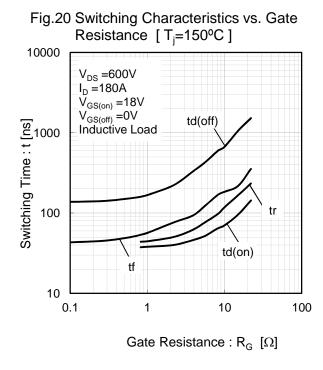
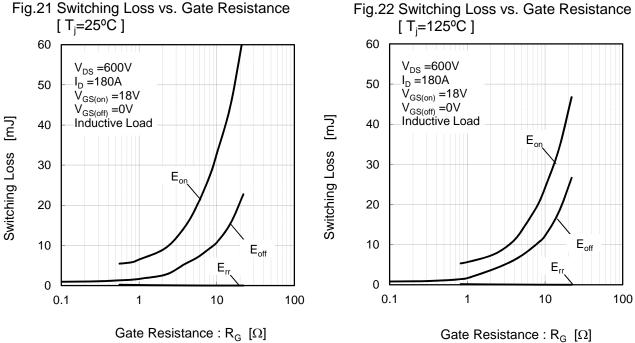
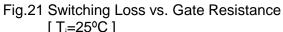
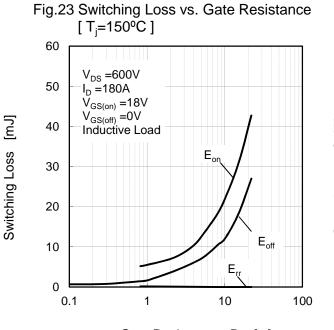


Fig.19 Switching Characteristics vs. Gate Resistance [T <sub>j</sub> =125°C]							
Switching Time : t [ns]		$V_{DS} = 600V$ $I_{D} = 180A$ $V_{GS(on)} = 18V$ $V_{GS(off)} = 0V$ Inductive Load	td(off)				
	100	tt	td(on)				
	10 0	.1 1	10	100			
Gate Resistance : $R_{G}$ [ $\Omega$ ]							



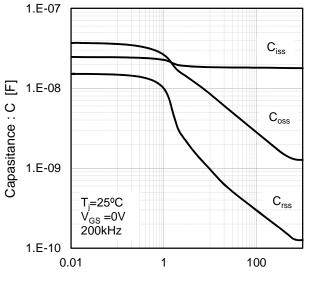




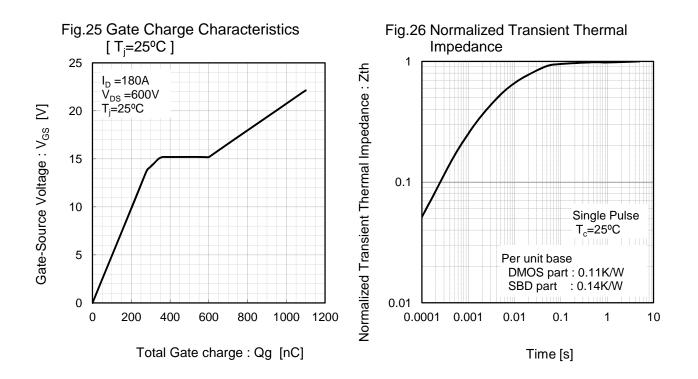


Gate Resistance :  $R_G$  [ $\Omega$ ]

Fig.24 Typical Capacitance vs. Drain-Source Voltage



Drain-Source Voltage : V<sub>DS</sub> [V]





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25.330.1653.1	25.330.4753.1	25.330.5253.1	25.334.3253.1	25.334.3353.1	25.350.2053.0	25.352.4753.1	25.522.3253.0	<u>T483C</u> <u>T484C</u>
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